The electrical switching properties of Ge_{10}Se_{5}Sb_{85} chalcogenide glass

S. Abouelhassan
Physics Department, Faculty of Science, Jazan University, KSA.

Abstract

Bulk ingot material of the ternary mixture Ge_{10}Se_{5}Sb_{85} was prepared by direct fusion of high purity constituent elements in vacuum sealed silica tube. The glassy nature of the prepared sample was confirmed by the X-ray diffraction (XRD) technique. Current -Voltage characteristics of the investigated glass have been carried out at different thicknesses and temperatures. Switching phenomenon at the turn-over point (TOP) from a high-resistance state (OFF state) to a negative-differential resistance-state (NDRS) was detected where the threshold parameters such as threshold dissipated power (P_{th}), threshold voltage( V_{th}), threshold current (I_{th}), threshold electric field (E_{th}) and threshold resistance (R_{th}) were determined at different thicknesses and ambient temperatures of the investigated samples. At the turn-over point, the activation energies (\Delta E_p, \Delta E_v, \Delta E_i, \Delta E_r and \Delta E_f) caused by the threshold dissipated powers, threshold voltages, threshold currents, threshold resistances and threshold electric fields respectively, were deducted at different thicknesses of the samples. The increasing in the ambient temperature of the investigated material (\Delta T), the temperature of the conduction path (T) and the Poole-Frenkel coefficient (\beta_{PF}) were determined at different ambient temperatures and thicknesses of the samples on the basis of the Joule heating effects. The activation energy of hopping (W), the activation energy of conduction \Delta E_o(eV), the hopping distance (d) of the charge carriers and the density of localized states N(E) were carried out due to Poole-Frenkel effect.

Keywords: Switching, chalcogenide, glass, Poole-Frenkel effect.

PACS Nos.:71.23An,71.23Cq,61.82Fk,31.43.Fs
1. INTRODUCTION

One of the most important class of glass is the chalcogenide glass. It contains at least one of the chalcogen elements; sulfur, selenium or tellurium, and is of essential interest owing to their wide application in optoelectronics, electrical and optical memory devices, modern electronics, and solar cells. Chalcogenide glass has attracted great attention because of their interesting semiconducting properties[1,2] that can be used in various solid state-devices, such as power control and information storage devices and also because of their more recent importance in optical recording[3]. They are considered as core materials for optical fibers for light transmission, particularly when small lengths and flexibility are required. Binary and ternary chalcogenide glasses exhibit many useful properties including, particularly, the switching phenomenon. In chalcogenide glass there exists two types of switching which are threshold and memory switching based on the way the glasses respond to the removal of the electric field after the switching event[4-12]. In the first type of switching, the ON state can be observed only when a current flows down to a certain holding voltage, while in the memory type one, the ON state is permanent until a suitable reset current pulse is applied on the sample[13]. The investigated glasses are important due to their interesting optical properties for their potential use as optical fibers, and electrical memory devices. The phenomenon of electrical switching in this type of glass has attracted several technological applications including power control and information storage.

In threshold-type switching, no structural changes occur and the process could be considered as reversible, whereas in memory-type switching, the material undergoes significant structural changes after transition and the process becomes completely irreversible[14,15]. The sudden change in the electrical resistance of chalcogenide glasses from a low conducting "OFF" state to a high conducting "ON" state under the effect of an appropriate electric field is commonly referred to as the switching/threshold electric field[16]. The switching process consists of a change of several orders of magnitude in electrical resistance caused by the application of a voltage higher than a critical voltage known as the threshold or switching voltage($v_{th}$), which corresponds to the threshold resistance ($R_{th}$), threshold current ($I_{th}$), threshold dissipated power ($P_{th}$), and threshold electric field ($E_{th}$). The application of a high electric field across high-resistivity materials sometimes results in either switching to a low-resistance state or entering a region of current- controlled negative resistance (CCNR)[17]. On the removal of the excitation electric field, threshold switching glasses revert to the OFF state whereas memory switches remain locked to the ON state[18]. Memory switches originate from the boundaries of the glass-forming regions, where glasses tend to crystallize when heated or cooled slowly[19-21]. There are several models proposed to understand the memory and threshold types of electrical switching, which are exhibited by the chalcogenide glasses. They have been classified into purely electronic[22], thermal and electrothermal models[23-27]. The electronic mechanism appears to govern thin films, while the electrothermal model appears to control the bulk specimens[28] and some investigators[23,29,30] have considered the threshold switching as an electronic
process. Investigations on the current-voltage characteristics and some studies on the dependence of the switching voltage and current on different material properties, such as composition, thickness, and pressure, will help investigators to understand the conduction mechanisms of the chalcogenide glasses. In the present work, the effect of thickness and temperature on the I-V characteristics and some switching parameters of Ge$_{10}$Se$_{5}$Sb$_{85}$ chalcogenide glasses will be investigate.

2. MATERIAL AND METHODS
Bulk chalcogenide glasses of Ge$_{10}$Se$_{5}$Sb$_{85}$ were prepared using the conventional melt quenching technique. Elemental constituents of 5N purity were weighed according to their atomic percentages and sealed in evacuated (10$^{-5}$ Torr) silica tubes then heated gradually to 1223 K for 15 h. The melt was continuously stirred to ensure homogeneity and then rapidly quenched in ice water. The glassy nature of the prepared samples was confirmed by the X-ray diffraction (XRD) technique using a Shimadzu XD-3 diffractometer with scanning velocity of 20 scans/min and Cu foil as the radiation source. Current–voltage characteristics were analyzed point by point using two electrometers (Keithley 617C). The glass samples were sandwiched between two electrodes, one of which was a pin electrode. The best fit for the resultant data points was made using the least-square method.

3. RESULTS AND DISCUSSION
3.1. Temperature dependence of the I-V characteristics of Ge$_{10}$Se$_{5}$Sb$_{85}$
Current-voltage(I-V) characteristics and switching phenomena of different thicknesses of amorphous Ge$_{10}$Se$_{5}$Sb$_{85}$ at different ambient temperatures are given in Figs. 1a-1d.
FIG. 1a-1d. The I-V characteristics of different thicknesses (t=0.064 cm, t=0.108 cm, t=0.138 cm and t=0.169 cm) for the glassy sample Ge$_5$Se$_{15}$Sb$_{85}$ at different ambient temperatures.

From the figures it can be noticed that the sample exhibit an Ohmic behavior at lower applied voltages which is characterized by the high resistance state (OFF state). The OFF state region, for the investigated samples (t=0.064 cm as a representative sample) can be redrawn, as shown in Figs. 2a-2d, where it can be observed that, as the voltage across the sample increases, then the current increase linearly (Ohmic behavior), forming the first region (o-a) in the OFF state, which represents the high-resistance state.
The electrical switching properties of Ge\textsubscript{10}Se\textsubscript{5}Sb\textsubscript{85} chalcogenide glass

FIG. 2a-2d. The I-V Characteristics of the sample (t=0.064 cm) at different ambient temperatures in the OFF state.

FIG. 3. The temperature dependence of the dc conductivity of Ge\textsubscript{10} Se\textsubscript{5} Sb\textsubscript{85} at different ambient temperatures.
The dc conductivity of the investigated samples was plotted (as shown in Fig. 3) against the ambient temperature, at different thickness, according to the relation:

\[ \sigma_{dc} = \sigma_0 \exp(-\Delta E_\sigma / k_B T) \]  

(1)

Where \( \Delta E_\sigma \) is the activation energy of conduction. The deduced values of \( \Delta E_\sigma \) at different thickness of the investigated samples are given in Table 2 where it can be noticed that as the sample thickness increases, the conductivity decreases which may be attributed to the increase in the disorder scattering process of the charge carriers which leads to increase the activation energy of conduction with the sample thickness as given in Table 2 and Fig. 9.

Table (1): The obtained values of the rise in the ambient temperature of the material (\( \Delta T_J \)), temperature of the conduction path (\( T^i \)) and the Poole-Frenkel coefficient (\( \beta_{PF} \)) at different temperatures and thicknesses of Ge$_{10}$Se$_5$Sb$_{85}$
The electrical switching properties of Ge\textsubscript{10}Se\textsubscript{5}Sb\textsubscript{85} chalcogenide glass

Table 2: The obtained values of the density of states \( N(\varepsilon_F) \), hopping distance \( d \) and hopping energy \( W(\text{eV}) \) at different temperatures and thicknesses of Ge\textsubscript{10} Se\textsubscript{5} Sb\textsubscript{85}

<table>
<thead>
<tr>
<th>Temperature (K)</th>
<th>( N_{\varepsilon_F} ) ( (10^4 \text{ cm}^{-3}) )</th>
<th>( d ) (\text{nm})</th>
<th>( W(\text{eV}) )</th>
<th>( N_{\varepsilon_F} ) ( (10^4 \text{ cm}^{-3}) )</th>
<th>( d ) (\text{nm})</th>
<th>( W(\text{eV}) )</th>
<th>( N_{\varepsilon_F} ) ( (10^4 \text{ cm}^{-3}) )</th>
<th>( d ) (\text{nm})</th>
<th>( W(\text{eV}) )</th>
<th>( N_{\varepsilon_F} ) ( (10^4 \text{ cm}^{-3}) )</th>
<th>( d ) (\text{nm})</th>
<th>( W(\text{eV}) )</th>
</tr>
</thead>
<tbody>
<tr>
<td>303</td>
<td>0.78</td>
<td>6.40</td>
<td>1.126</td>
<td>4.2</td>
<td>4.23</td>
<td>0.737</td>
<td>10.9</td>
<td>3.34</td>
<td>0.582</td>
<td>14.5</td>
<td>3.11</td>
<td>0.543</td>
</tr>
<tr>
<td>323</td>
<td>2.99</td>
<td>4.55</td>
<td>0.645</td>
<td>8.5</td>
<td>4.10</td>
<td>0.762</td>
<td>11.7</td>
<td>3.23</td>
<td>0.601</td>
<td>16.2</td>
<td>2.98</td>
<td>0.554</td>
</tr>
<tr>
<td>343</td>
<td>12.91</td>
<td>3.16</td>
<td>0.774</td>
<td>13.9</td>
<td>3.92</td>
<td>0.674</td>
<td>14.0</td>
<td>3.04</td>
<td>0.581</td>
<td>19.2</td>
<td>2.81</td>
<td>0.555</td>
</tr>
<tr>
<td>363</td>
<td>34.66</td>
<td>2.18</td>
<td>0.655</td>
<td>36.1</td>
<td>2.40</td>
<td>0.602</td>
<td>38.4</td>
<td>2.64</td>
<td>0.551</td>
<td>39.6</td>
<td>2.53</td>
<td>0.529</td>
</tr>
<tr>
<td>380</td>
<td>45.89</td>
<td>0.189</td>
<td>0.456</td>
<td>51.4</td>
<td>0.16</td>
<td>0.429</td>
<td>47.5</td>
<td>0.002</td>
<td>0.390</td>
<td>52.87</td>
<td>0.0013</td>
<td>0.34</td>
</tr>
<tr>
<td>410</td>
<td>90.72</td>
<td>0.003</td>
<td>0.290</td>
<td>78.6</td>
<td>0.002</td>
<td>0.136</td>
<td>88.34</td>
<td>0.001</td>
<td>0.106</td>
<td>92.09</td>
<td>0.0005</td>
<td>0.106</td>
</tr>
</tbody>
</table>

The region o-a is followed by a second one (a-b), which exhibits exponential behavior verifying the relation [31-33]:

\[
I = I_o \exp(V/V_o)^{1/2}
\]  (2)

where \( I_o \) is the potential difference across the sample, \( V_o = 4k_B^2T^2/\beta_{PF} \), with \( k_B \) being the Boltzmann constant, \( T \) is the ambient temperature of the sample, \( t \) is the sample thickness, and \( \beta_{PF} \) is the Poole-Frenkel coefficient. The relationship between \( \ln I \) and \( V^{1/2} \) at different constant ambient temperatures for the sample \( t = 0.064 \text{ cm} \) is shown in Figs. 2a-2b, where \( \beta_{PF} \) is determined and given in table 1. From this table it can be observed that \( \beta_{PF} \) tends to decrease as the ambient temperature increases, while it exhibits increasing behavior as the sample thickness increases which indicates that the conduction mechanism in the (a-b) region of the OFF state follows either the Schottky emission [34] or the Poole-Frenkel-type conduction [35]. The region (b-c) in the OFF state seems to be linear as shown in Figs. 2(b) and 2(c).

The samples exhibit a sudden change from a high-resistance (OFF) state to a negative-differential-resistance state (NDRS). The point at which the curves switch from the OFF state to the NDRS is called the turn-over point (TOP). The switching behavior is accompanied by the burning or heating of the conduction path which in turn may lead to the Joule heating effect during the initial stage of switching because of the high resistance of the samples that leads to an increase in the conduction path temperature (\( T^* \)). This temperature was calculated for different thicknesses of the
samples at constant ambient temperatures according to the relation[36,37]:

\[ T^\Delta = T + \Delta T \]

where \( T \) is the ambient temperature and \( \Delta T \) is the increase in the temperature of the conduction path, which is given by:

\[ \Delta T = kT^2/[\Delta E_\sigma - kT] \]

where \( \Delta E_\sigma \) is the activation energy of conduction and \( k \) is the Boltzmann constant.

The calculated values of \( T^\Delta \) and \( \Delta T \) are given in Table 1, where it can be observed that as the ambient temperature increases, the temperature of the conduction path \( T^\Delta \) increases consequently, \( \Delta T \) increases, which enhances the proposed concept of the Joule heating effect and is in agreement with previously reported results[37-40].

The parameters related to the TOP, such as the threshold voltage \( V_{th} \), threshold current \( I_{th} \), threshold resistance \( R_{th} \) and threshold power \( P_{th} \), are calculated and their dependences on the sample thickness and temperature are discussed below.

### 3.2. Temperature dependence of the threshold voltage of Ge\(_{10}\) Se\(_5\) Sb\(_{85}\)

The temperature dependence of the threshold voltage (\( V_{th} \)) at different thicknesses for the sample Ge\(_{10}\)Se\(_5\)Sb\(_{85}\) is shown in Fig.4 where an increase in \( V_{th} \) as the ambient temperature increases is observed, verifying the relation[38]:

\[ V_{th} = V_o \exp(\Delta E_v / kT), \]

where \( V_o \) is a temperature-independent parameter and \( \Delta E_v \) is the threshold voltage activation energy related to the temperature of the conduction path. The linear plots between \( \ln (V_{th}) \)and \( (1/T) \) can be understood[37,39] in terms of the electrothermal model for the pre-switching region as follows: The temperature dependence of the threshold voltage is an important factor that characterizes the robustness of the material against thermal degradation and hence the stability of the material for device applications[41]. The memory switching in chalcogenide glasses involves the formation of a conducting crystalline filament in the material, and hence a decrease in threshold voltage is expected[42]. Most amorphous materials contain dipoles dispersed randomly through the amorphous matrix. As an electric field is applied, these dipoles tend to orient in the direction of this field. The orientation process depends on the viscosity of the amorphous matrix as well as on the applied electric field. As the temperature of the conduction path increases, its viscosity decreases, enhancing the orientation process, up to the TOP. At this point, the resultant force of the resistance for dipole orientation in a viscous amorphous medium diminishes therefore, the switching process take occurs. Thus, as the ambient temperature
The electrical switching properties of Ge\text{10}Se\text{5}Sb\text{85} chalcogenide glass increases, the viscosity of the conduction path decreases, therefore the field’s ability to cause a maximum dipole orientation should decrease\cite{37,39}.

\textbf{FIG. 4.} The temperature dependence of the threshold voltage at constant thickness of the sample.

The thickness dependence of the threshold voltage for the investigated sample can be observed in Fig.4, where an increase in $V_{th}$ with the sample thickness is obtained. It has been suggested earlier\cite{43} that $V_{th}$ varies with $t$, $t^{1/2}$, or $t^2$ depending on whether the mechanism responsible for switching is electronic, purely thermal, or electrothermal respectively. The results indicate the presence of electrothermal processes operating during the progress of the crystallization mechanism in the conduction path. It has been considered that as the sample thickness increases, the dissipated power inside the conduction path increases, which leads to an increase in the required field, consequently the threshold voltage increases, which is in agreement with previously reported results\cite{44-46}. The values of $\Delta E_v$ at different thicknesses were deduced using the least-squares fitting method and are given in Fig.9. From this figure it can be observed that $\Delta E_v$ decreases as the thickness increases. The decrease in $\Delta E_v$ may be interpreted in terms of the localized state concept, which is calculated according to the relation\cite{47}:

$$\beta_{PF} = \left[ \frac{64 \alpha^4 t^4}{\pi e N(E_F)} \right]^{1/4}$$

where $\alpha$ is the radius of the electron wave function, $t$ is the sample thickness, and $N(E_F)$ is the density of localized states at the Fermi level. The calculated values of $N(E_F)$ are given in Table 2, where it can be observed that $N(E_F)$ tends to increase as the sample thickness increases, which results in a decrease in the hopping distance of
the charge carriers between the filled and empty states. The calculated values of the hopping distance \( d \), according to the relation\[48-50\]:
\[
d = \left[ \frac{9}{8 N(E_F) \pi \alpha k T} \right]^{1/4},
\]
are given in Table 2 where it can be noted that a decrease in \( d \) consequently results in a decrease in the required average hopping energy \( W(eV) \) between the filled and empty states. The calculated values of \( W(eV) \) according to the relation\[50\]:
\[
W(eV) = \left[ \frac{3}{4 \pi d^3 N(E_F)} \right]
\]
are given in Table 2.

### 3.3. Temperature dependence of the threshold current of Ge\(_{10}\)Se\(_{5}\)Sb\(_{85}\)

Fig.5 shows the temperature dependence of the threshold current \( I_{th} \) for the investigated sample, which yields straight lines obeying the equation\[38\]:
\[
I_{th} = I_o \exp \left( \frac{-\Delta E_i}{kT} \right),
\]
where \( I_o \) is an independent term and \( \Delta E_i \) is the activation energy term related to the conduction mechanism. From this figure, it can be noticed that as the ambient temperature increases the threshold current increases, which may be attributed to an increase in the area of the conduction path where the crystallization process is enhanced. The deduced values of \( \Delta E_i \) at different thicknesses are given in Fig.9. It can be observed that as the sample thickness increases, \( \Delta E_i \) tends to decrease. The decreasing behavior may be attributed to the increased area of the conduction path.

![Graph](image)

**FIG. 5.** The temperature dependence of the threshold current at constant thickness of the sample.
3.4. Temperature dependence of the threshold resistance of Ge\textsubscript{10}Se\textsubscript{5}Sb\textsubscript{85}

Fig. 6 shows the temperature dependence of the threshold resistance $R_{th}$ for the investigated sample, which yields straight lines obeying the equation\[38\]:

$$R_{th} = R_o \exp \left( \frac{\Delta E_r}{kT} \right),$$

(8)

where $R_o$ is an independent term and $\Delta E_r$ is the activation energy term related to the conduction mechanism. It is observed that as the ambient temperature increases, the threshold resistance decreases. The threshold resistance increase as the thickness of the sample increases. This may be attributed to an increase in the conduction path area. The values of $\Delta E_r$ were deduced for different thicknesses of the investigated sample using the least-squares fitting method and are given in Fig.9. From this figure it can be observed that $\Delta E_r$ tends to decreases gradually with the sample thickness, which is in agreement with previously reported results\[37-46\].

3.5. Temperature dependence of the threshold dissipated power of Ge\textsubscript{10}Se\textsubscript{5}Sb\textsubscript{85}

The threshold dissipated power $P_{th}$ ($P_{th} = V_{th} I_{th}$) in the conduction path of the sample at the threshold voltage was calculated at different thicknesses of the investigated sample and is plotted (as shown in Fig.7 as $\ln P_{th}$ against $1/T$ according to the relation\[38\]:

$$P_{th} = P_o \exp \left( -\Delta E_p / kT \right),$$

(9)

where $\Delta E_p$ is the activation energy at the threshold power. From Fig.7 it can be observed that $P_{th}$ decreases as the temperature increases. This may be due to the
decrease in the number of collisions between the charge carriers in the samples. The values of $\Delta E_p$ were deduced and plotted as given in Fig.9 at different thicknesses of the investigated samples. It can be observed that $\Delta E_p$ decreases as the sample thickness increases which may be attributed to the deterioration of the scattering process between the charge carriers as a result of the enhanced process in the crystallization mechanism at the threshold point.

![Figure 7](image)

**FIG. 7.** The temperature dependence of the threshold power at constant thickness of the sample.

3.6. Temperature dependence of the threshold Electric field of Ge$_{10}$Se$_5$Sb$_{85}$

The threshold Electric field $E_{th}$ ($V_{th}=t$) in the conduction path of the sample at the (TOP) was calculated at different thicknesses of the investigated sample and is plotted (as shown in Fig.8) as $\ln E_{th}$ against $1/T$ obeying the relation,

$$E_{th}=E_0 \exp (\Delta E_f / kT)$$  \hspace{1cm} (10)

where $\Delta E_f$ is the activation energy at the (TOP). From Fig.8 it can be noticed that as the temperature of the sample increases, the threshold electric field decrease. The deduced values of $\Delta E_f$ are plotted against the sample thickness as given in Fig.9. It can be noticed that as the sample thickness increases, $\Delta E_f$ decrease which may be attributed to the increasing in the orientation process of the dipoles in the direction of the applied electric field.
The electrical switching properties of Ge$_{10}$Se$_5$Sb$_{85}$ chalcogenide glass

**FIG. 8.** The Temperature dependence of the threshold Electric field ($E_{th}$) of Ge$_{10}$Se$_5$ Sb$_{85}$

**FIG. 9.** The thickness dependence of the activation energy of Ge$_{10}$Se$_5$ Sb$_{85}$
4. CONCLUSION

Bulk chalcogenide glasses of Ge\textsubscript{10}Se\textsubscript{5}Sb\textsubscript{85} were prepared using the conventional melt quenching technique. The glassy nature of the prepared samples was confirmed by the X-ray diffraction technique. Switching phenomenon at the turn-over point (TOP) from a high-resistance state (OFF state) to a negative-differential resistance-state (NDRS) was detected where the threshold parameters such as threshold dissipated power ($P_{th}$), threshold voltage ($V_{th}$), threshold current ($I_{th}$), threshold electric field ($E_{th}$), and threshold resistance ($R_{th}$) were determined at different thicknesses and ambient temperatures of the investigated samples. The activation energies of the investigated samples ($\Delta E_{p}$, $\Delta E_{v}$, $\Delta E_{i}$, $\Delta E_{f}$ and $\Delta E_{r}$), at the turn-over point, indicate a decreasing behavior with the sample thickness. The obtained values of the rise in the ambient temperature of the material ($\Delta T$), temperature of the conduction path ($T_c$) and the Poole-Frenkel coefficient ($\beta_{PF}$) at different temperatures and thicknesses were explained in terms of Poole-Frenkel effect.

ACKNOWLEDGMENT

I’m gratefully acknowledge the deanship of scientific research, Jazan University, KSA, for the financial support, through the project number 7013/6/36.

REFERENCES

The electrical switching properties of Ge$_{10}$Se$_{5}$Sb$_{85}$ chalcogenide glass